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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. ....09/468,247  
 Priority Filing Date .....12/20/99  
 Inventor.....Perino et al.  
 Applicant.....Rambus, Inc.  
 Priority Group Art Unit .....2833  
 Priority Examiner .....Paumen  
 Attorney's Docket No. ....RB1-035USC3  
 Title: Chip Socket Assembly and Chip File Assembly for Semiconductor Chips

PRELIMINARY AMENDMENT

To: Commissioner of Patents and Trademarks,  
 Washington, D.C. 20231

From: Daniel L. Hayes (Tel. 509-324-9256; Fax 509-323-8979)  
 Customer No. 29501



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PATENT &amp; TRADEMARK OFFICE

AMENDMENTSIn the Specification:

On page 2, prior to the heading "FIELD OF THE INVENTION", please  
 insert the following:

--RELATED APPLICATIONS

This is a continuation of U.S. Patent Application Serial No. 09/468,247,  
 filed December 20, 1999, which is now U.S. Patent No. ---

In the Claims:

Please cancel ☒ claims 1-67.

Please add the following new claims 68-90.